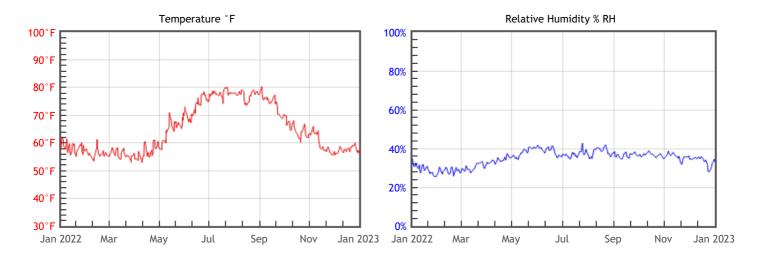
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## **Preservation Environment Evaluation**

Type of Decay	Risks & Metrics	Evaluation & General Comments
Natural Aging Chemical decay of organic materials	OK TWPI = 67	Generally OK, but fast decaying organic materials such as acidic paper, color photographs and cellulosic plastics will be at elevated risk due to the cumulative effects of temperature and humidity
Mechanical Damage Physical damage to hygroscopic materials	GOOD  % DC = 0.49 % EMC min = 5.9 % EMC max = 7.7	Minimal risk of physical damage to most hygroscopic materials such as paintings, rare books and furniture.
Mold Risk Mold growth in area or on collection objects	GOOD  MRF = 0	Minimal risk of mold growth.
Metal Corrosion Corrosion of metal components or objects	OK % EMC max = 7.7	Generally OK, but archeological or salt-encrusted metals may corrode due to extended periods of moderately high levels of humidity.

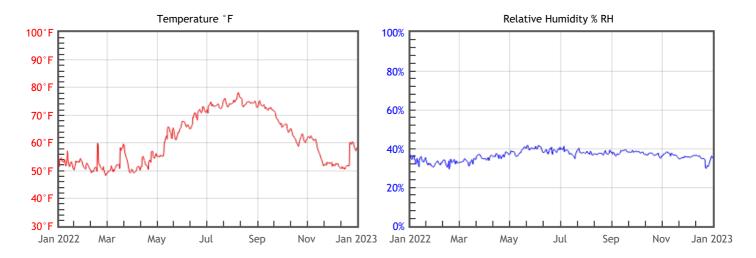
# Graphs



Temperature		Relative H	Relative Humidity		oint
T°F Mean	64.8	%RH Mean	35	DP°F Mean	36.1
T°F Median	62.6	%RH Median	36	DP°F Median	34.9
T°F Stdev	8.6	%RH Stdev	4	DP°F Stdev	9.6
T°F Min	51.8	%RH Min	21	DP°F Min	20.1
T°F Max	81.6	%RH Max	43	DP°F Max	54.1

Type of Decay	Risks & Metrics	Evaluation & General Comments
Natural Aging Chemical decay of organic materials	GOOD TWPI = 82	Slow rate of chemical decay in organic materials such as paper, leather, textiles, plastics and dyes
Mechanical Damage Physical damage to hygroscopic materials	GOOD  % DC = 0.33 % EMC min = 6.6 % EMC max = 7.7	Minimal risk of physical damage to most hygroscopic materials such as paintings, rare books and furniture.
Mold Risk  Mold growth in area or on collection objects	GOOD  MRF = 0	Minimal risk of mold growth.
Metal Corrosion Corrosion of metal components or objects	OK % EMC max = 7.7	Generally OK, but archeological or salt-encrusted metals may corrode due to extended periods of moderately high levels of humidity.

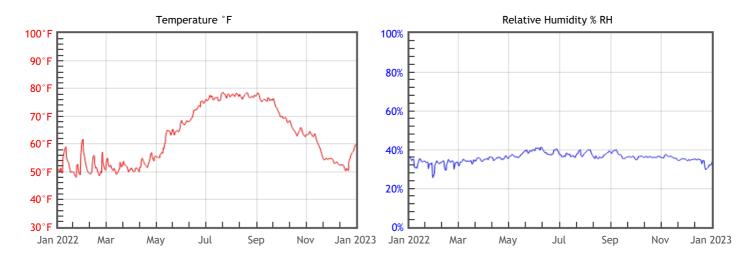
# Graphs



Temperature		Relative H	Relative Humidity		Dew Point	
T°F Mean	61.2	%RH Mean	36	DP°F Mean	34.2	
T°F Median	60.4	%RH Median	37	DP°F Median	33.5	
T°F Stdev	9.1	%RH Stdev	3	DP°F Stdev	9.2	
T°F Min	47.7	%RH Min	27	DP°F Min	20.4	
T°F Max	79	%RH Max	44	DP°F Max	51.2	

Type of Decay	Risks & Metrics	Evaluation & General Comments
Natural Aging Chemical decay of organic materials	OK TWPI = 71	Generally OK, but fast decaying organic materials such as acidic paper, color photographs and cellulosic plastics will be at elevated risk due to the cumulative effects of temperature and humidity
Mechanical Damage Physical damage to hygroscopic materials	GOOD  % DC = 0.29 % EMC min = 6.5 % EMC max = 7.6	Minimal risk of physical damage to most hygroscopic materials such as paintings, rare books and furniture.
Mold Risk  Mold growth in area or on collection objects	GOOD MRF = 0	Minimal risk of mold growth.
Metal Corrosion Corrosion of metal components or objects	OK % EMC max = 7.6	Generally OK, but archeological or salt-encrusted metals may corrode due to extended periods of moderately high levels of humidity.

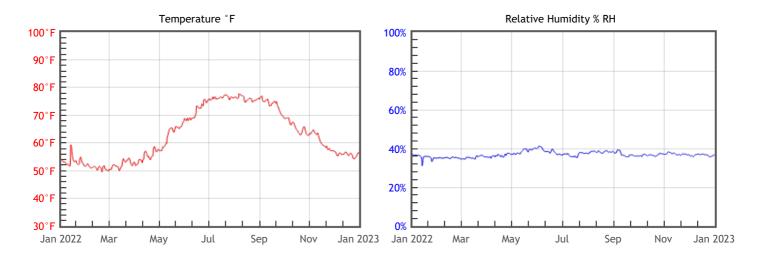
# Graphs



Temperature		Relative H	Relative Humidity		Point
T°F Mean	62.6	%RH Mean	36	DP°F Mean	35.1
T°F Median	62.5	%RH Median	36	DP°F Median	35.3
T°F Stdev	10.3	%RH Stdev	2	DP°F Stdev	10.3
T°F Min	47.9	%RH Min	24	DP°F Min	20.1
T°F Max	80	%RH Max	41	DP°F Max	52.5

Type of Decay	Risks & Metrics	Evaluation & General Comments
Natural Aging Chemical decay of organic materials	OK TWPI = 72	Generally OK, but fast decaying organic materials such as acidic paper, color photographs and cellulosic plastics will be at elevated risk due to the cumulative effects of temperature and humidity
Mechanical Damage Physical damage to hygroscopic materials	GOOD  % DC = 0.18 % EMC min = 7.1 % EMC max = 7.7	Minimal risk of physical damage to most hygroscopic materials such as paintings, rare books and furniture.
Mold Risk  Mold growth in area or on collection objects	GOOD  MRF = 0	Minimal risk of mold growth.
Metal Corrosion Corrosion of metal components or objects	OK % EMC max = 7.7	Generally OK, but archeological or salt-encrusted metals may corrode due to extended periods of moderately high levels of humidity.

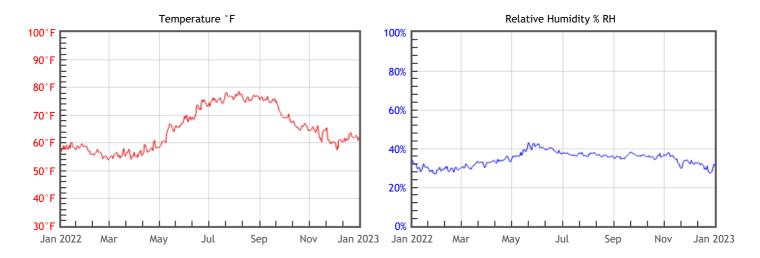
# Graphs



Temperature		Relative H	Relative Humidity		oint
T°F Mean	62.9	%RH Mean	37	DP°F Mean	36.2
T°F Median	62.5	%RH Median	37	DP°F Median	36
T°F Stdev	9.3	%RH Stdev	1	DP°F Stdev	8.8
T°F Min	49.4	%RH Min	30	DP°F Min	23.1
T°F Max	78.6	%RH Max	41	DP°F Max	50.6

Type of Decay	Risks & Metrics	Evaluation & General Comments
Natural Aging Chemical decay of organic materials	OK TWPI = 68	Generally OK, but fast decaying organic materials such as acidic paper, color photographs and cellulosic plastics will be at elevated risk due to the cumulative effects of temperature and humidity
Mechanical Damage Physical damage to hygroscopic materials	GOOD  % DC = 0.5 % EMC min = 6.1 % EMC max = 7.9	Minimal risk of physical damage to most hygroscopic materials such as paintings, rare books and furniture.
Mold Risk Mold growth in area or on collection objects	GOOD MRF = 0	Minimal risk of mold growth.
Metal Corrosion Corrosion of metal components or objects	OK % EMC max = 7.9	Generally OK, but archeological or salt-encrusted metals may corrode due to extended periods of moderately high levels of humidity.

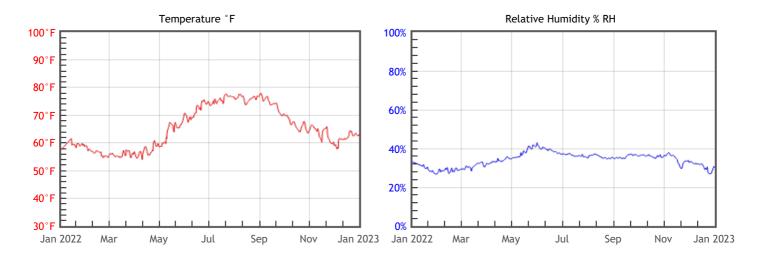
# Graphs



Temperature		Relative H	Relative Humidity		Dew Point	
T°F Mean	65.2	%RH Mean	34	DP°F Mean	36.3	
T°F Median	64.3	%RH Median	35	DP°F Median	36.1	
T°F Stdev	7.6	%RH Stdev	4	DP°F Stdev	8.7	
T°F Min	53.5	%RH Min	25	DP°F Min	22	
T°F Max	79.2	%RH Max	44	DP°F Max	51	

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# Graphs



Temperature		Relative H	Relative Humidity		Point
T°F Mean	65.4	%RH Mean	34	DP°F Mean	36.4
T°F Median	64.7	%RH Median	35	DP°F Median	36.9
T°F Stdev	7.5	%RH Stdev	4	DP°F Stdev	8.5
T°F Min	53.7	%RH Min	26	DP°F Min	22.4
T°F Max	79	%RH Max	43	DP°F Max	50.1